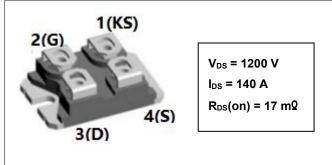
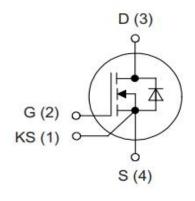




S2M0016120N **1200V SIC POWER MOSFET**



Circuit Diagram



Description

S2M0016120N is single SiC Power MOSFET packaged in SOT-227 case. The device is a high voltage n-channel enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S2M0016120N is ideal for energy sensitive, high frequency applications in challenging environments.

Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) = 17m^Q .
- · Fast switching speed and low switching losses.
- · Very fast and robust intrinsic body diode.

Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)

Maximum Ratings(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Drain Source Voltage	V _{DSS}	V _{GS} = 0V, I _{DS} = 100uA, T _C = 25°C	1200	V
Gate Source Voltage	V _{GSS}	T _C = 25°C, Absolute maximum values, AC (f>1Hz)	-10 to +25	V
Gate Source Voltage	V _{GSOP}	T _C = 25°C Recommended Operational Values	-5 to +20	V
Continuous Drain Current	I _D	V _{GS} = 20V, T _C = 25°C	140	А
	I _D	V _{GS} = 20V, T _C = 100°C	99	Α
Pulsed Drain Current	I _{D,pulse}	T _C =25°C	250	А
Power Dissipation	PD	T _C =25°C	517	W
SOT-227 Mounting Torque		M4 Screw	1	Nm

- China Germany Korea Singapore United States •
- http://www.smc-diodes.com sales@ smc-diodes.com •





Electrical Characteristics(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition	Min.	Тур.	Max.	Unit s	
Drain Source Breakdown Voltage	$V_{(BR)DSS}$	V _{GS} = 0V, I _D = 100uA	1200			٧	
		$V_{DS} = V_{GS}$, $I_D = 23mA$	1.8	2.55	3.6		
Gate Threshold Voltage	$V_{\text{GS(th)}}$	V _{DS} = V _{GS} , I _D = 23mA, T _J = 175 °C		1.85		٧	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 1200V, V _{GS} = 0V		1	10	uA	
Gate Source Leakage Current	I _{GSS}	V _{GS} = 20V, V _{DS} = 0V		10	250	nA	
		V _{GS} = 20V, I _D = 75A	11.2	17	23	mΩ	
Drain Source On-State	_	V _{GS} = 18V, I _D = 75A		19			
Resistance	$R_{DS(on)}$	V _{GS} = 20V, I _D = 75A, T _J = 175 °C		28			
		V _{GS} = 18V, I _D = 75A, T _J = 175 °C		29		mΩ	
	_	V _{DS} = 20 V, I _D = 75 A		24		S	
Transconductance	gfs	V _{DS} = 20 V, I _D = 75 A, T _J = 175 °C		18		_	
Input Capacitance	C _{ISS}	V _{GS} = 0V,		4540			
Output Capacitance	Coss	V _{DS} = 1000V		210		pF	
Reverse Transfer Capacitance	C _{RSS}	V _{AC} = 25mV		29.3			
Coss Stored Energy	Eoss	f=100kHz		122		uJ	
Turn-On Switching Energy	Eon	$V_{DS} = 800V, V_{GS} = -5/+20V$ ID =75A, RG(ext)=2.5 Ω		0.44			
Turn-Off Switching Energy	Eoff	L=65.7uH, T _J = 25 °C		0.44		mJ	
Turn-On Delay Time	$t_{d(on)}$	V _{DS} = 800V, V _{GS} = -5/20V		13.76			
Rise Time	t _r	$I_D = 75A$, $R_{G(ext)} = 2.5\Omega$, L=67.5uH		21.12			
Turn-Off Delay Time	$t_{\text{d(off)}}$	Inductive Load Timing relative to		33.92		ns	
Fall Time	t _f	VDS Per IEC60747-8-4 pg 83		8.96			
Internal Gate Resistance	R _{G(int)}	f = 1MHz, VAC = 25 mV, D-S short		1.5		Ω	
Gate to Source Charge	Q_{gs}	V _{DS} = 800V, V _{GS} = -5/20V		290			
Gate to Drain Charge	Q_{gd}	I _D = 75A		37.2		nC	
Total Gate Charge	Q_g			285			

[•] China - Germany - Korea - Singapore - United States • • http://www.smc-diodes.com - sales@ smc-diodes.com •





Reverse Diode Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Diode Forward Voltage	V _{SD}	V _{GS} = -5V, I _{SD} = 37.5A	3.5		V
	V _{SD}	V _{GS} = -5V, I _{SD} = 37.5A, T _J = 175°C	3.0		V
Continuous Diode Forward Current	Is	V _{GS} = -5V, T _C = 25°C		112	Α
Reverse Recovery Time	t _{rr}	V _{GS} = -5V, I _{SD} = 75A, T _J = 175°C	15		ns
Reverse Recovery Charge	Qrr	V _R = 800V	201		μС
Peak Reverse Recovery Current	I _{mm}	dif/dt= 2664A/µs	21		Α

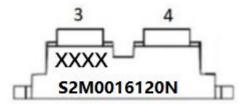
Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	R ₀ JC	DC operation	0.29	°C/W

Ordering Information:

Device	Package	Shipping
S2M0016120N	SOT-227	36pcs /BULK

Marking Diagram



Where XXXXX is YYWWL

= Device Type S2M 0016

= R_{DS}(on) = Reverse Voltage (1200V) 120

= Package SSG = SSG = Year ww = Week = Lot Number

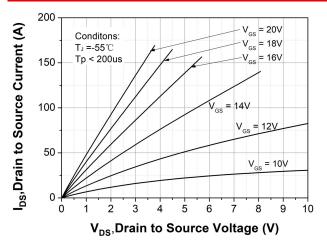
Cautions: Molding resin

Epoxy resin UL:94V-0





Ratings and Characteristics Curves



Conditons:
T_J = 25 °C
Tp < 200us

Tp < 200us

V_{GS} = 14V

V_{GS} = 12V

V_{DS}, Drain to Source Voltage (V)

200

Figure 1. Output Characteristics T_J = -55 °C

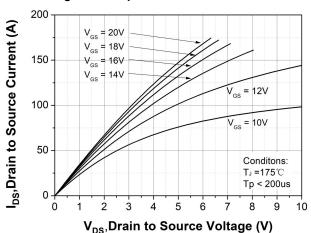


Figure 2. Output Characteristics T_J = 25 °C

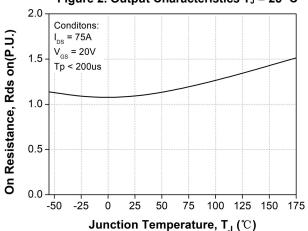


Figure 3. Output Characteristics T_J = 175°C

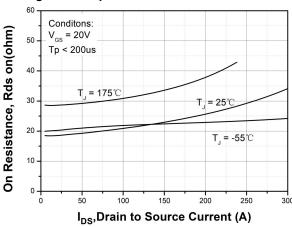


Figure 4. Normalized On-Resistance vs. Temperature

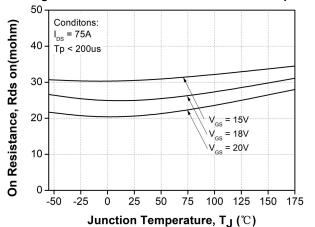


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

- China Germany Korea Singapore United States •
- http://www.smc-diodes.com sales@ smc-diodes.com •

RoHS



Technical Data Data Sheet N2643 REV.-

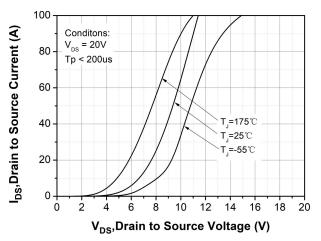


Figure 7. Transfer Characteristic for Various Junction Temperatures

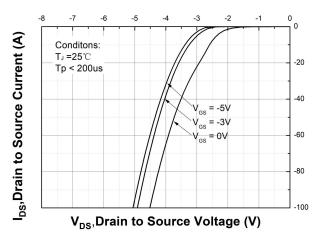


Figure 9. Body Diode Characteristic at T_J = 25 °C

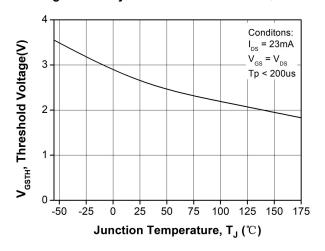


Figure 11. Threshold Voltage vs. Temperature

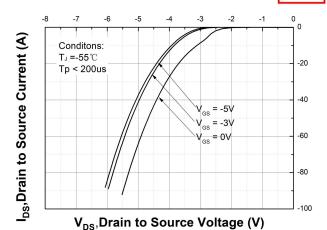


Figure 8. Body Diode Characteristic at T_J = -55 °C

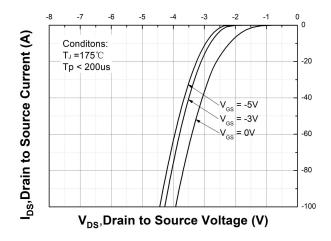


Figure 10. Body Diode Characteristic at T_J = 175 °C

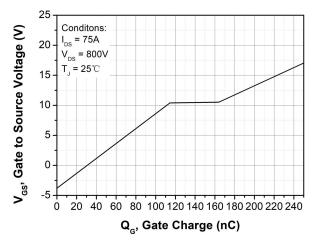


Figure 12. Gate Charge Characteristic

- China Germany Korea Singapore United States
 - http://www.smc-diodes.com sales@ smc-diodes.com •





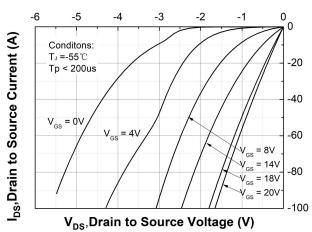


Figure 13. 3rd Quadrant Characteristic at T_J = -55 °C

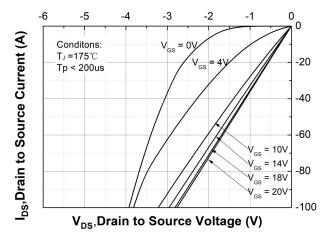


Figure 15. 3rd Quadrant Characteristic at T_J = 175°C

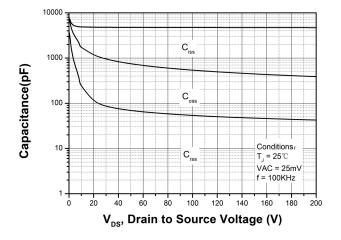


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

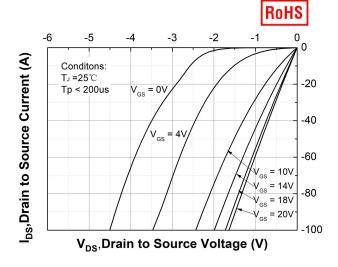


Figure 14. 3rd Quadrant Characteristic at T_J = 25 °C

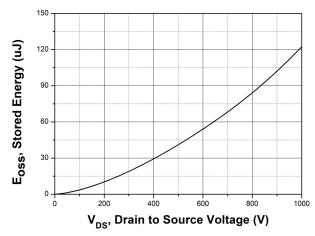


Figure 16. Output Capacitor Stored Energy

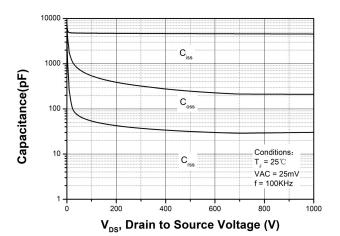
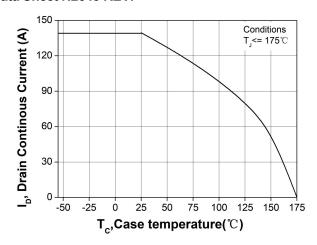


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1000V)

- China Germany Korea Singapore United States
 - http://www.smc-diodes.com sales@ smc-diodes.com •







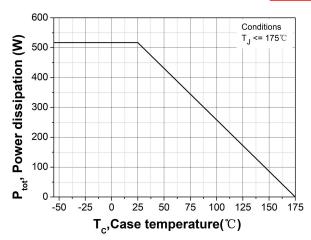
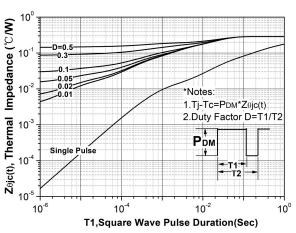


Figure 19. Continuous Drain Current Derating vs.

Case Temperature

Figure 20. Maximum Power Dissipation Derating vs. Case Temperature



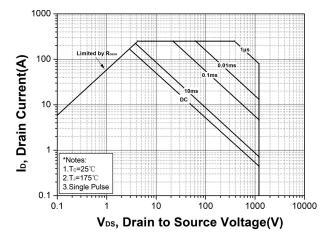
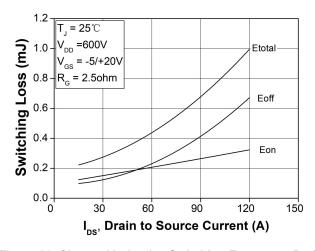


Figure 21. Transient Thermal Impedance (Junction - Case)

Figure 22. Safe Operating Area



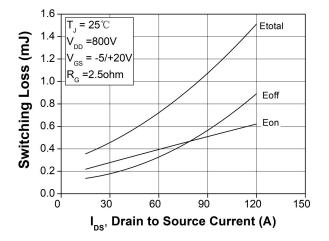


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 600V)

Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

- China Germany Korea Singapore United States
 - http://www.smc-diodes.com sales@ smc-diodes.com •





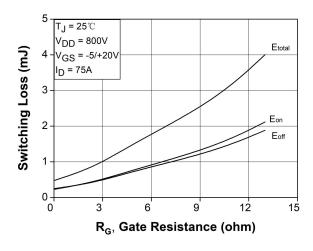


Figure 25. Clamped Inductive Switching Energy vs. R_{G(ext)}

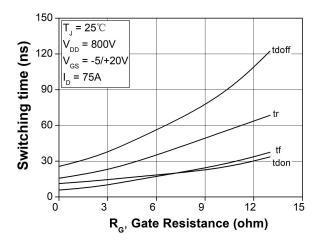


Figure 27. Switching Times vs. R_{G(ext)}

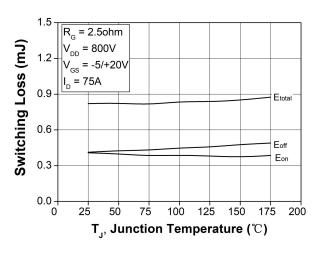


Figure 26. Clamped Inductive Switching Energy vs. Temperature

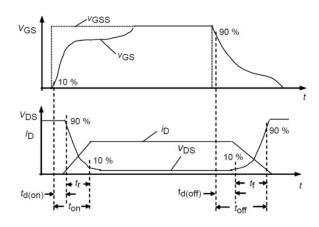
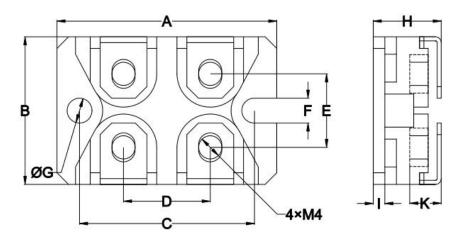


Figure 28. Switching Times Definition





Mechanical Dimensions SOT-227



SYMBOL	Dimensions in millimeters		
	Min.	Max.	
Α	37.8	38.2	
В	24.8	25.2	
С	29.9	30.5	
D	14.5	15.5	
E	12.2	13.2	
F	4.1	4.31	
G	φ4.1	φ4.31	
Н	11	12.5	
I	1.9	2.1	
K	4.3	6.5	

S2M0016120N



Technical Data Data Sheet N2643 REV.-



DISCLAIMER:

- 1- The information given herein, including the specifications and dimensions, is subject to change without prior notice to improve product characteristics. Before ordering, purchasers are advised to contact the SMC Diode Solutions sales department for the latest version of the datasheet(s).
- 2- In cases where extremely high reliability is required (such as use in nuclear power control, aerospace and aviation, traffic equipment, medical equipment, and safety equipment), safety should be ensured by using semiconductor devices that feature assured safety or by means of users' fail-safe precautions or other arrangement.
- 3- In no event shall SMC Diode Solutions be liable for any damages that may result from an accident or any other cause during operation of the user's units according to the datasheet(s). SMC Diode Solution assumes no responsibility for any intellectual property claims or any other problems that may result from applications of information, products or circuits described in the datasheets.
- 4- In no event shall SMC Diode Solutions be liable for any failure in a semiconductor device or any secondary damage resulting from use at a value exceeding the absolute maximum rating.
- 5- No license is granted by the datasheet(s) under any patents or other rights of any third party or SMC Diode Solutions.
- 6- The datasheet(s) may not be reproduced or duplicated, in any form, in whole or part, without the expressed written permission of SMC Diode Solutions.
- 7- The products (technologies) described in the datasheet(s) are not to be provided to any party whose purpose in their application will hinder maintenance of international peace and safety nor are they to be applied to that purpose by their direct purchasers or any third party. When exporting these products (technologies), the necessary procedures are to be taken in accordance with related laws and regulations..